



BUK7Y2R0-40H

N-channel 40 V, 2.0 mΩ standard level MOSFET in LPAK56

10 January 2025

Product data sheet

1. General description

Automotive qualified N-channel MOSFET using the latest Trench 9 low ohmic superjunction technology, housed in a robust LPAK56 package. This product has been fully designed and qualified to meet AEC-Q101 requirements delivering high performance and endurance.

2. Features and benefits

- Fully automotive qualified to AEC-Q101:
 - 175 °C rating suitable for thermally demanding environments
- Trench 9 Superjunction technology:
 - Reduced cell pitch enables enhanced power density and efficiency with lower R_{DSon} in same footprint
 - Improved SOA and avalanche capability compared to standard TrenchMOS
 - Tight $V_{GS(th)}$ limits enable easy paralleling of MOSFETs
- LPAK Gull Wing leads:
 - High Board Level Reliability absorbing mechanical stress during thermal cycling, unlike traditional QFN packages
 - Visual (AOI) soldering inspection, no need for expensive x-ray equipment
 - Easy solder wetting for good mechanical solder joint
- LPAK copper clip technology:
 - Improved reliability, with reduced R_{th} and R_{DSon}
 - Increases maximum current capability and improved current spreading

3. Applications

- 12 V automotive systems
- Motors, lamps and solenoid control
- Start-Stop micro-hybrid applications
- Transmission control
- Ultra high performance power switching

4. Quick reference data

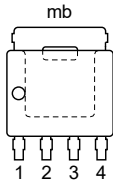
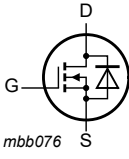
Table 1. Quick reference data

| Symbol | Parameter | Conditions | Min | Typ | Max | Unit |
|-------------------------------|----------------------------------|--|------|------|-----|------|
| V_{DS} | drain-source voltage | $25\text{ °C} \leq T_j \leq 175\text{ °C}$ | - | - | 40 | V |
| I_D | drain current | $V_{GS} = 10\text{ V}; T_{mb} = 25\text{ °C}$ | - | - | 120 | A |
| P_{tot} | total power dissipation | $T_{mb} = 25\text{ °C};$ Fig. 1 | - | - | 217 | W |
| Static characteristics | | | | | | |
| R_{DSon} | drain-source on-state resistance | $V_{GS} = 10\text{ V}; I_D = 25\text{ A}; T_j = 25\text{ °C};$ Fig. 10 | 1.07 | 1.53 | 2 | mΩ |

| Symbol | Parameter | Conditions | Min | Typ | Max | Unit |
|-------------------------|-------------------|--|-----|------|------|------|
| Dynamic characteristics | | | | | | |
| Q _{GD} | gate-drain charge | I _D = 25 A; V _{DS} = 32 V; V _{GS} = 10 V; Fig. 12 ; Fig. 13 | - | 10.8 | 27.3 | nC |
| Source-drain diode | | | | | | |
| Q _r | recovered charge | I _S = 25 A; dI _S /dt = -100 A/μs; V _{GS} = 0 V; V _{DS} = 20 V | - | 21 | - | nC |
| S | softness factor | I _S = 25 A; dI _S /dt = -100 A/μs; V _{GS} = 0 V; V _{DS} = 20 V; T _j = 25 °C | - | 0.8 | - | |

5. Pinning information

Table 2. Pinning information

| Pin | Symbol | Description | Simplified outline | Graphic symbol |
|-----|--------|-----------------------------------|--|---|
| 1 | S | source |  LFPAK56; Power-SO8 (SOT669) |  mbb076 |
| 2 | S | source | | |
| 3 | S | source | | |
| 4 | G | gate | | |
| mb | D | mounting base; connected to drain | | |

6. Ordering information

Table 3. Ordering information

| Type number | Package | | |
|------------------------------|--------------------|--|------------------------|
| | Name | Description | Version |
| BUK7Y2R0-40H | LFPAK56; Power-SO8 | plastic, single-ended surface-mounted package; 4 terminals | SOT669 |

7. Marking

Table 4. Marking codes

| Type number | Marking code |
|--------------|--------------|
| BUK7Y2R0-40H | 72H040 |

8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). T_j = 25 °C unless otherwise stated.

| Symbol | Parameter | Conditions | Min | Max | Unit |
|------------------|-------------------------|---|-----|-----|------|
| V _{DS} | drain-source voltage | 25 °C ≤ T _j ≤ 175 °C | - | 40 | V |
| V _{GS} | gate-source voltage | | [1] | 20 | V |
| P _{tot} | total power dissipation | T _{mb} = 25 °C; Fig. 1 | - | 217 | W |
| I _D | drain current | V _{GS} = 10 V; T _{mb} = 25 °C | - | 120 | A |
| I _{DM} | peak drain current | pulsed; t _p ≤ 10 μs; T _{mb} = 25 °C; Fig. 2 | - | 600 | A |
| T _{stg} | storage temperature | | -55 | 175 | °C |

| Symbol | Parameter | Conditions | | Min | Max | Unit |
|----------------------|--|--|---------|-----|-----|------|
| T _j | junction temperature | | | -55 | 175 | °C |
| Source-drain diode | | | | | | |
| I _S | source current | T _{mb} = 25 °C | [2] | - | 120 | A |
| I _{SM} | peak source current | pulsed; t _p ≤ 10 μs; T _{mb} = 25 °C | | - | 600 | A |
| Avalanche ruggedness | | | | | | |
| E _{DS(AL)S} | non-repetitive drain-source avalanche energy | I _D = 120 A; V _{sup} ≤ 40 V; R _{GS} = 50 Ω; V _{GS} = 10 V; T _{j(init)} = 25 °C; unclamped; Fig. 3 | [3] [4] | - | 108 | mJ |

- [1] Refer to application note AN90001 for further information.
- [2] 120A continuous current has been successfully demonstrated during application tests. Practically the current will be limited by PCB, thermal design and operating temperature.
- [3] Single-pulse avalanche rating limited by maximum junction temperature of 175 °C.
- [4] Refer to application note AN10273 for further information.

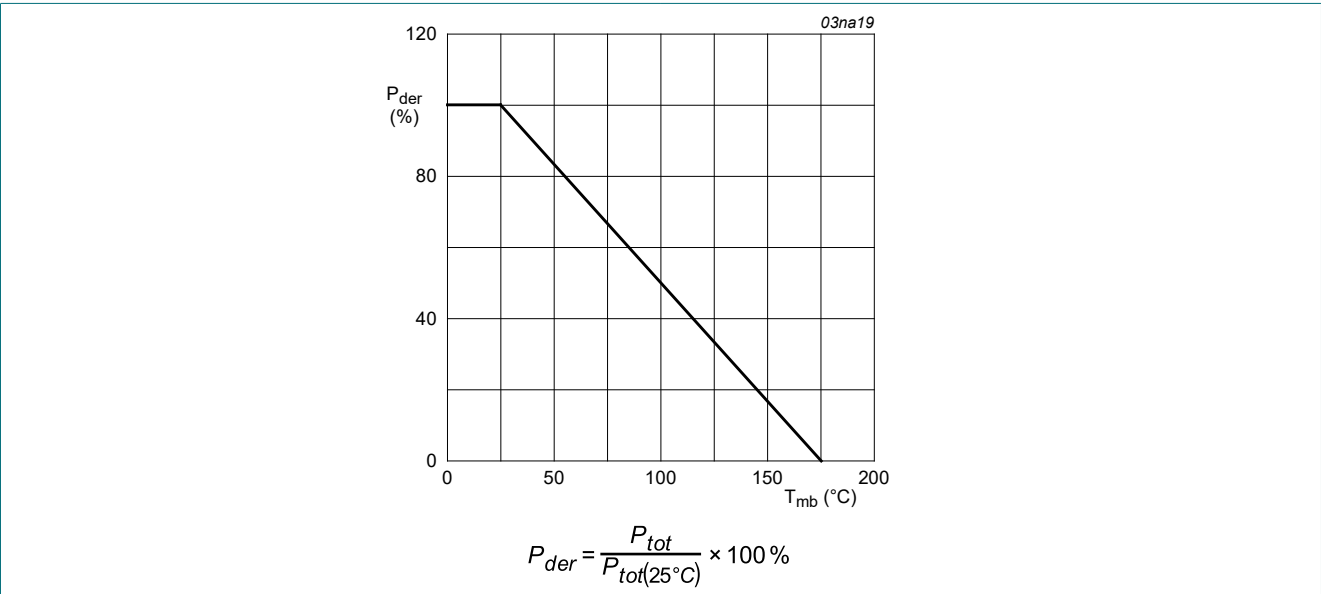


Fig. 1. Normalized total power dissipation as a function of mounting base temperature

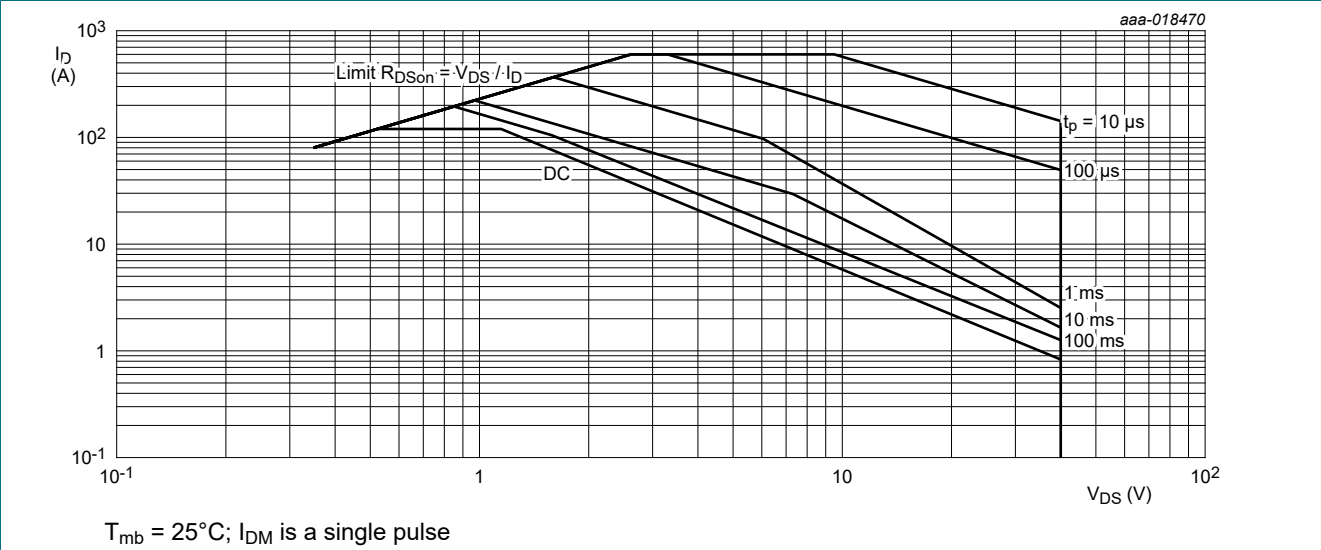
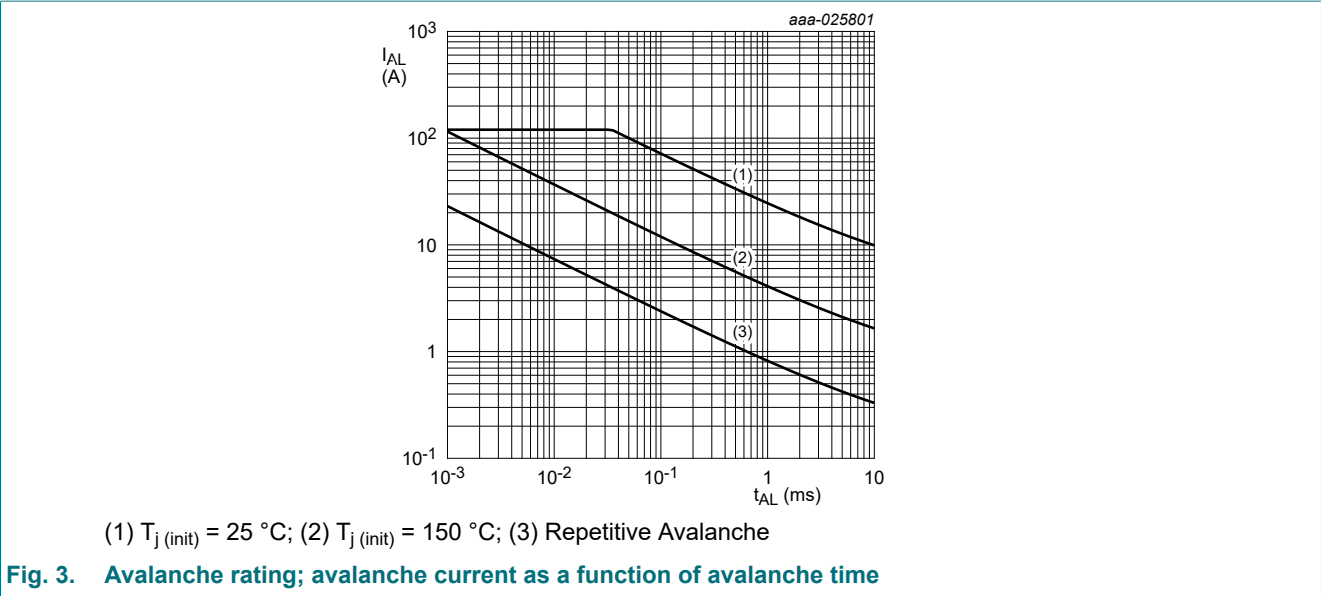


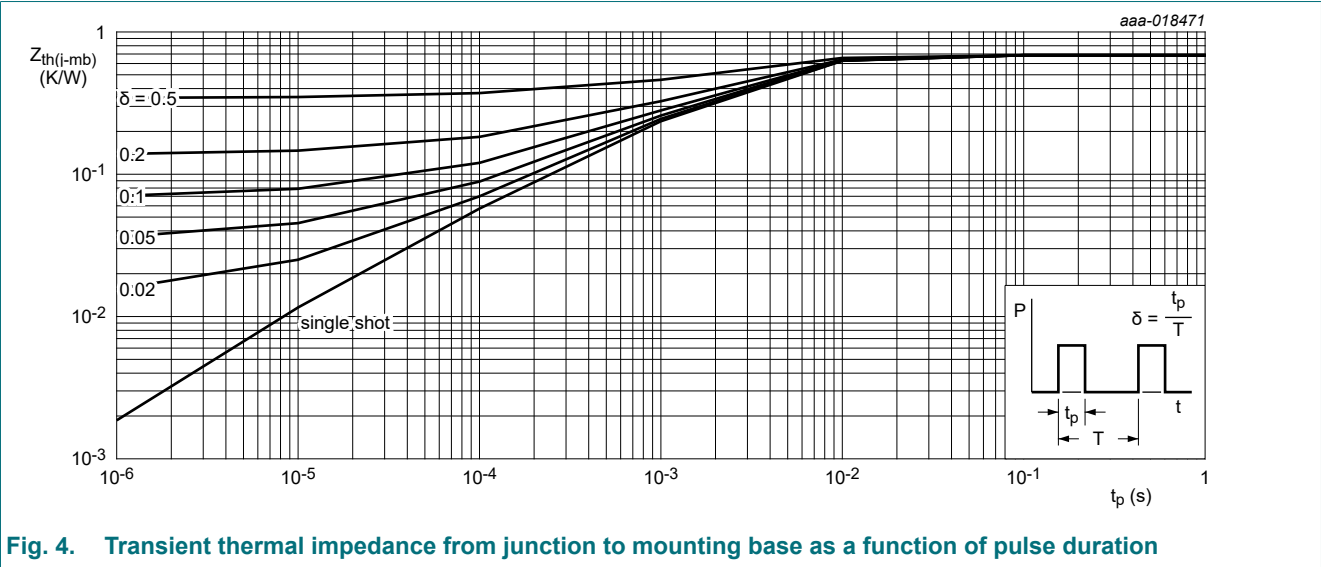
Fig. 2. Safe operating area; continuous and peak drain currents as a function of drain-source voltage



9. Thermal characteristics

Table 6. Thermal characteristics

| Symbol | Parameter | Conditions | | Min | Typ | Max | Unit |
|----------------|---|------------|--|-----|-----|------|------|
| $R_{th(j-mb)}$ | thermal resistance from junction to mounting base | Fig. 4 | | - | 0.5 | 0.69 | K/W |



10. Characteristics

Table 7. Characteristics

| Symbol | Parameter | Conditions | | Min | Typ | Max | Unit |
|-------------------------|----------------------------------|---|--|------|------|------|------|
| Static characteristics | | | | | | | |
| V _{(BR)DSS} | drain-source breakdown voltage | I _D = 250 μA; V _{GS} = 0 V; T _j = 25 °C | | 40 | 42.7 | - | V |
| | | I _D = 250 μA; V _{GS} = 0 V; T _j = -40 °C | | - | 40.3 | - | V |
| | | I _D = 250 μA; V _{GS} = 0 V; T _j = -55 °C | | 36 | 39.7 | - | V |
| V _{GS(th)} | gate-source threshold voltage | I _D = 1 mA; V _{DS} =V _{GS} ; T _j = 25 °C; Fig. 8 ; Fig. 9 | | 2.4 | 3 | 3.6 | V |
| | | I _D = 1 mA; V _{DS} =V _{GS} ; T _j = -55 °C; Fig. 8 | | - | - | 4.3 | V |
| | | I _D = 1 mA; V _{DS} =V _{GS} ; T _j = 175 °C; Fig. 8 | | 1 | - | - | V |
| I _{DSS} | drain leakage current | V _{DS} = 40 V; V _{GS} = 0 V; T _j = 25 °C | | - | 0.2 | 1 | μA |
| | | V _{DS} = 16 V; V _{GS} = 0 V; T _j = 125 °C | | - | 2 | 10 | μA |
| | | V _{DS} = 40 V; V _{GS} = 0 V; T _j = 175 °C | | - | 180 | 500 | μA |
| I _{GSS} | gate leakage current | V _{GS} = 20 V; V _{DS} = 0 V; T _j = 25 °C | | - | 2 | 100 | nA |
| | | V _{GS} = -16 V; V _{DS} = 0 V; T _j = 25 °C | | - | 2 | 100 | nA |
| R _{DSon} | drain-source on-state resistance | V _{GS} = 10 V; I _D = 25 A; T _j = 25 °C; Fig. 10 | | 1.07 | 1.53 | 2 | mΩ |
| | | V _{GS} = 10 V; I _D = 25 A; T _j = 105 °C; Fig. 11 | | 1.52 | 2.33 | 3.18 | mΩ |
| | | V _{GS} = 10 V; I _D = 25 A; T _j = 125 °C; Fig. 11 | | 1.68 | 2.59 | 3.5 | mΩ |
| | | V _{GS} = 10 V; I _D = 25 A; T _j = 175 °C; Fig. 11 | | 2.11 | 3.24 | 4.36 | mΩ |
| R _G | gate resistance | f = 1 MHz; T _j = 25 °C | | 0.36 | 0.9 | 2.3 | Ω |
| Dynamic characteristics | | | | | | | |
| Q _{G(tot)} | total gate charge | I _D = 25 A; V _{DS} = 32 V; V _{GS} = 10 V; Fig. 12 ; Fig. 13 | | - | 52.6 | 90.5 | nC |
| Q _{GS} | gate-source charge | | | - | 14.8 | 22.5 | nC |
| Q _{GD} | gate-drain charge | | | - | 10.8 | 27.3 | nC |
| C _{iss} | input capacitance | V _{DS} = 25 V; V _{GS} = 0 V; f = 1 MHz; T _j = 25 °C; Fig. 14 | | - | 3633 | 5450 | pF |
| C _{oss} | output capacitance | | | - | 984 | 1377 | pF |
| C _{rss} | reverse transfer capacitance | | | - | 188 | 415 | pF |
| t _{d(on)} | turn-on delay time | V _{DS} = 30 V; R _L = 1.5 Ω; V _{GS} = 10 V; R _{G(ext)} = 5 Ω | | - | 13.5 | - | ns |
| t _r | rise time | | | - | 12 | - | ns |
| t _{d(off)} | turn-off delay time | | | - | 31.4 | - | ns |
| t _f | fall time | | | - | 15.1 | - | ns |
| Source-drain diode | | | | | | | |
| V _{SD} | source-drain voltage | I _S = 25 A; V _{GS} = 0 V; T _j = 25 °C; Fig. 15 | | - | 0.8 | 1.2 | V |
| t _{rr} | reverse recovery time | I _S = 25 A; dI _S /dt = -100 A/μs; V _{GS} = 0 V; V _{DS} = 20 V | | - | 29 | - | ns |
| Q _r | recovered charge | | | - | 21 | - | nC |
| S | softness factor | I _S = 25 A; dI _S /dt = -100 A/μs; V _{GS} = 0 V; V _{DS} = 20 V; T _j = 25 °C | | - | 0.8 | - | |
| | | I _S = 25 A; dI _S /dt = -500 A/μs; V _{GS} = 0 V; V _{DS} = 20 V; T _j = 25 °C | | - | 0.7 | - | |

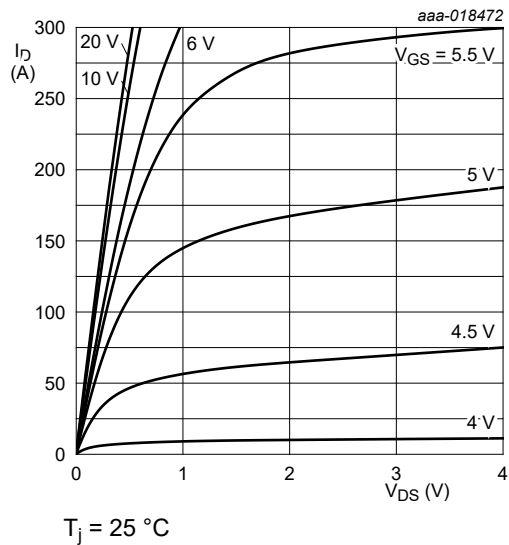


Fig. 5. Output characteristics; drain current as a function of drain-source voltage; typical values

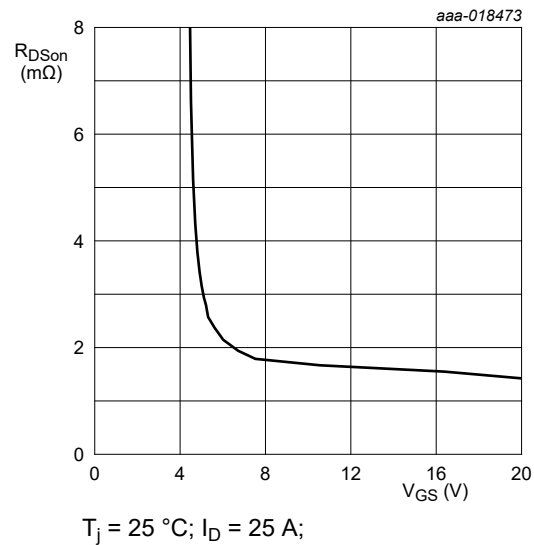


Fig. 6. Drain-source on-state resistance as a function of gate-source voltage; typical values

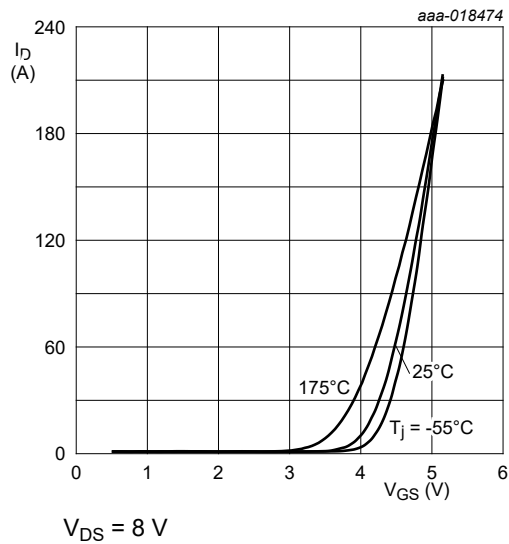


Fig. 7. Transfer characteristics; drain current as a function of gate-source voltage; typical values

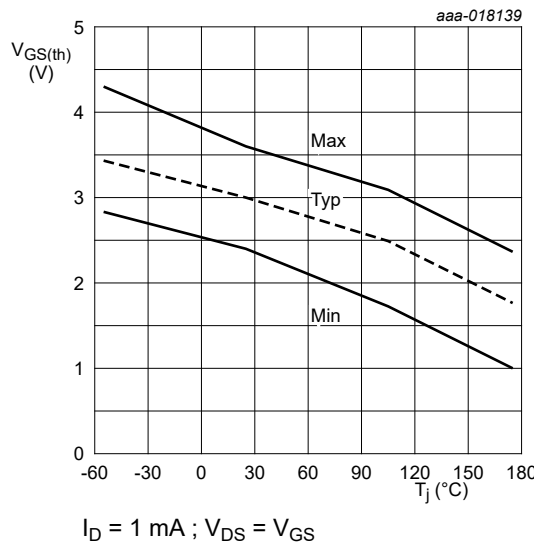


Fig. 8. Gate-source threshold voltage as a function of junction temperature

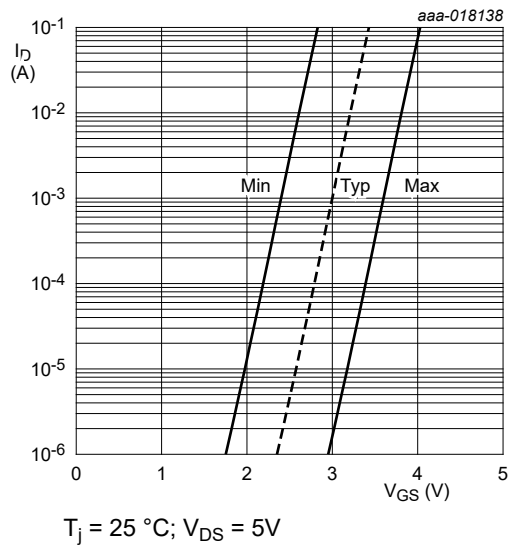


Fig. 9. Sub-threshold drain current as a function of gate-source voltage

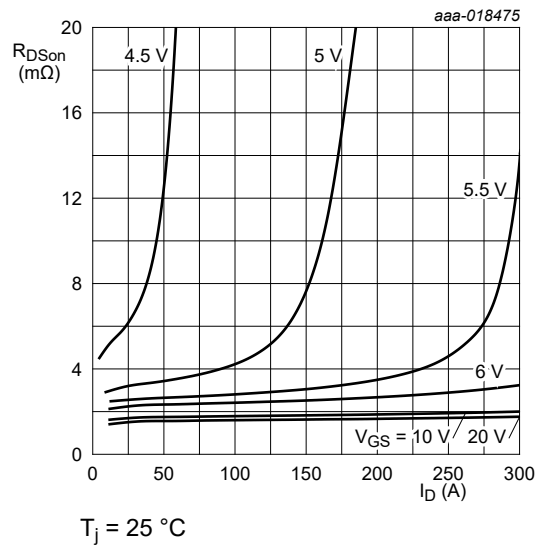


Fig. 10. Drain-source on-state resistance as a function of drain current; typical values

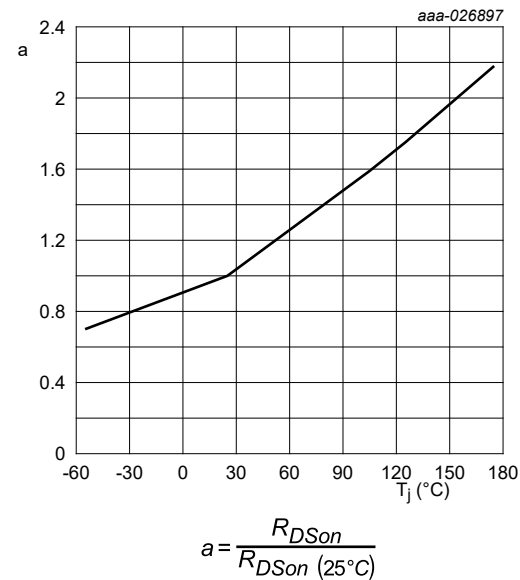


Fig. 11. Normalized drain-source on-state resistance factor as a function of junction temperature

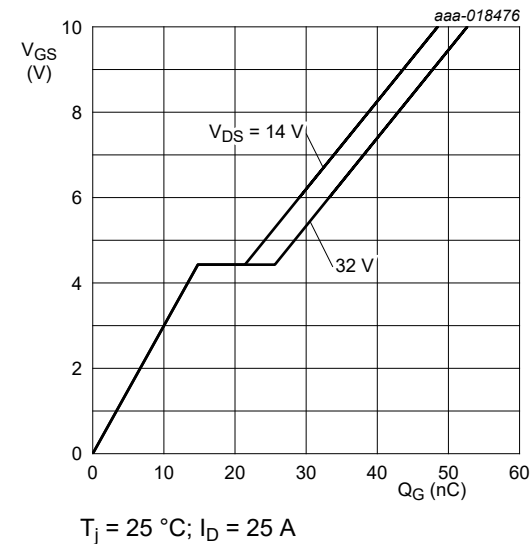


Fig. 12. Gate-source voltage as a function of gate charge; typical values

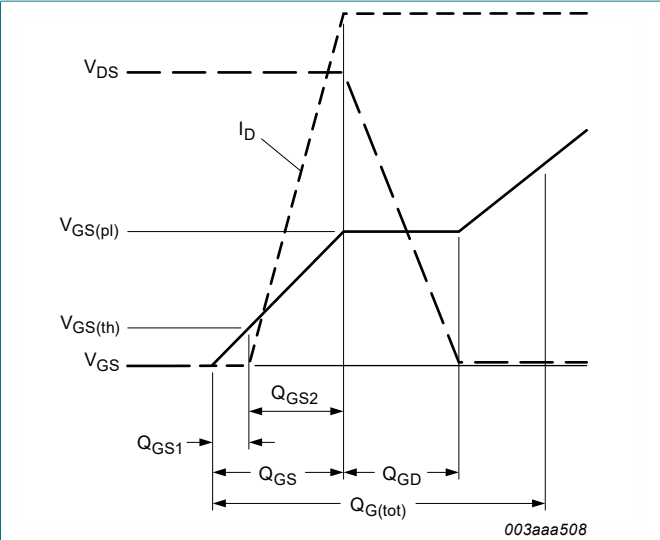


Fig. 13. Gate charge waveform definitions

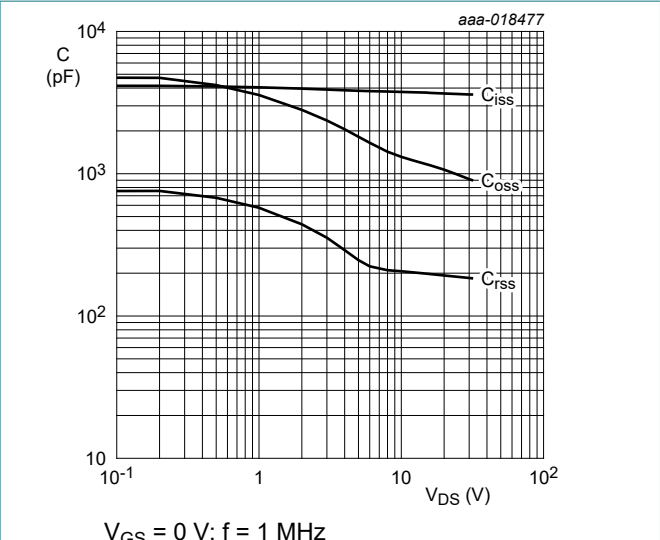


Fig. 14. Input, output and reverse transfer capacitances as a function of drain-source voltage; typical values

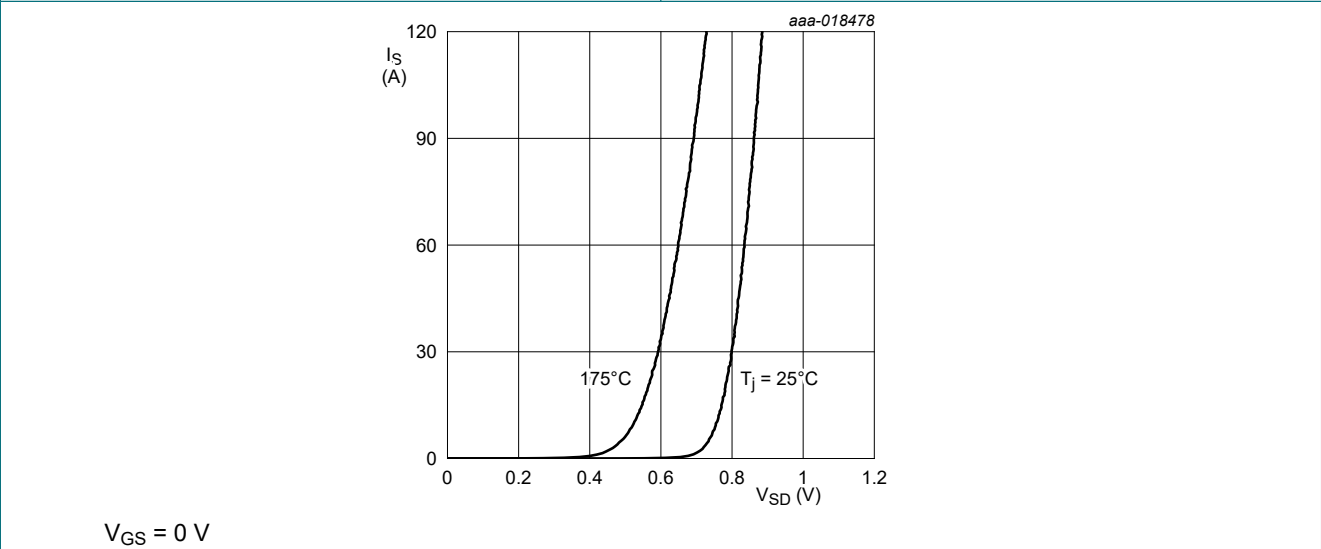


Fig. 15. Source-drain (diode forward) current as a function of source-drain (diode forward) voltage; typical values

11. Package outline

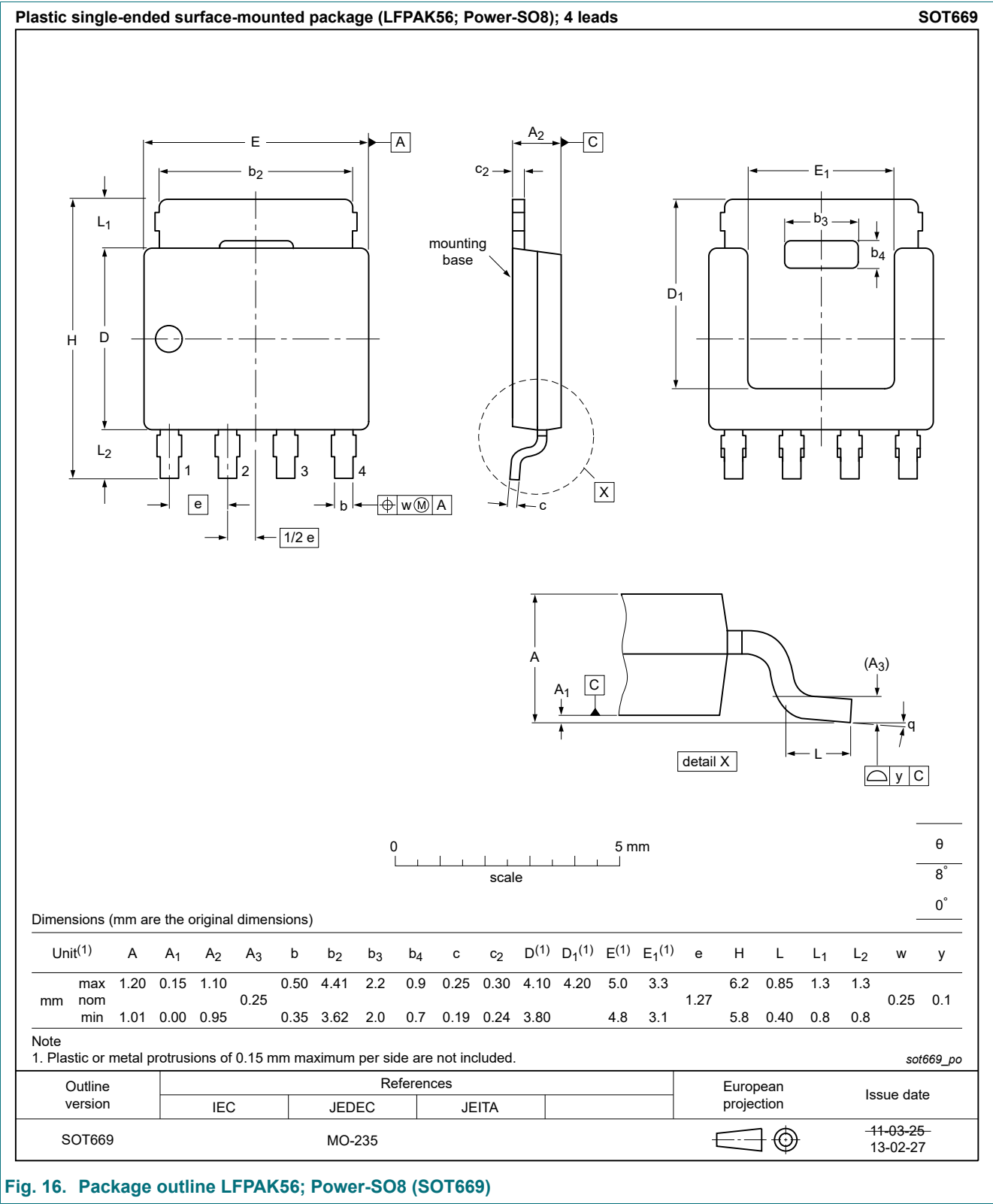


Fig. 16. Package outline LPAK56; Power-SO8 (SOT669)

12. Soldering

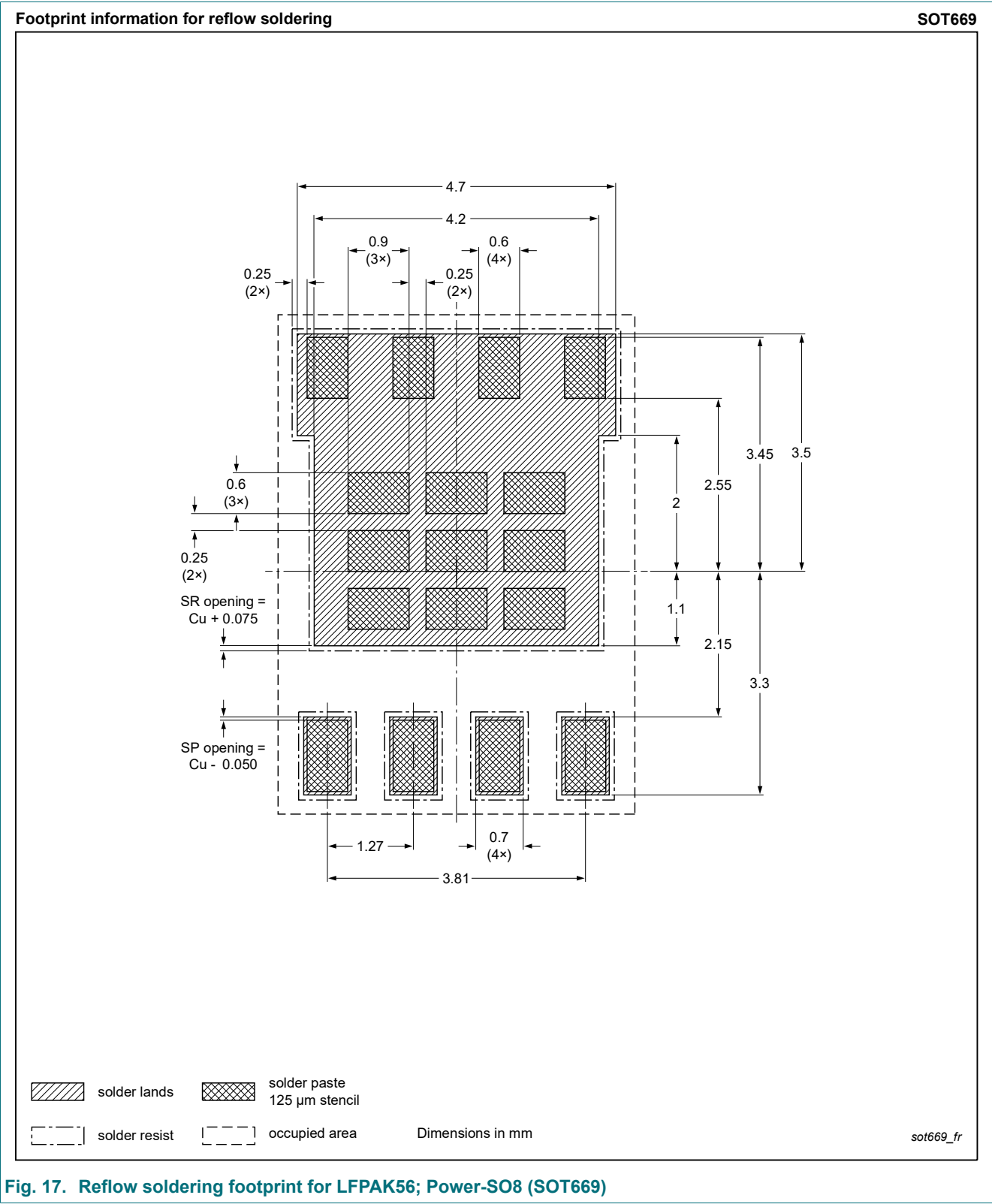
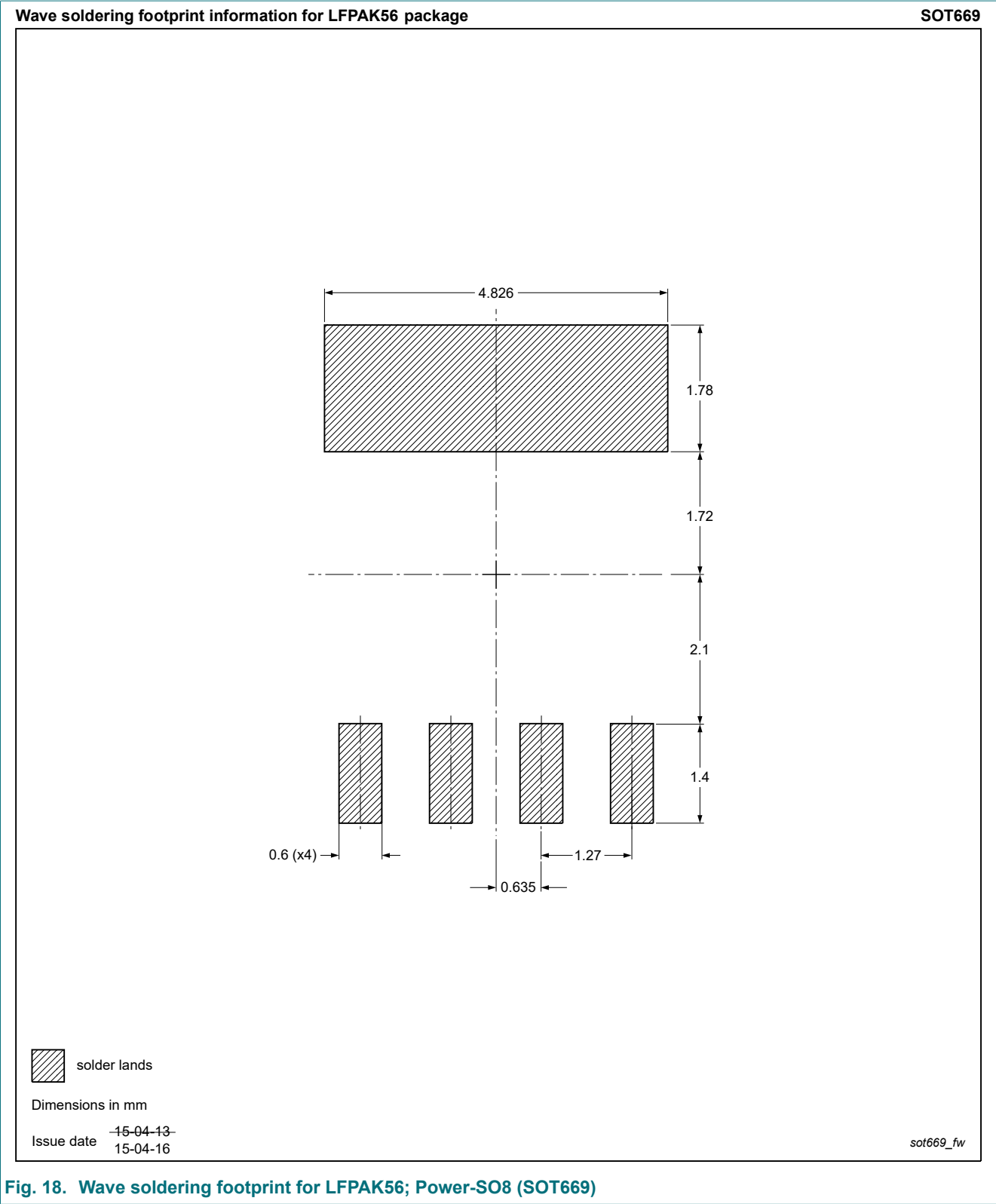


Fig. 17. Reflow soldering footprint for LPAK56; Power-SO8 (SOT669)



13. Legal information

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|--------------------------------|--------------------|---|
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